

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE6003X uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$, low gate charge. This device is suitable for use as a Battery protection or in other switching application.

General Features

V_{DS} =60V,I_D =3A

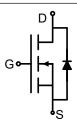
 $R_{DS(ON)}$ <78m Ω @ V_{GS} =10V

 $R_{DS(ON)}$ < 96m Ω @ V_{GS} =4.5V

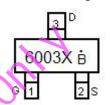
- High power and current handing capability
- Lead free product is acquired
- Surface mount package

Application

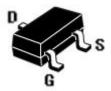
- Battery switch
- ●DC/DC converter



Schematic Diagram



Marking and Pin Assignment



SOT-23 Top View

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
6003X	NCE6003X	SOT-23	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	60	V
Gate-Source Voltage	VGS	±20	V
Drain Current-Continuous	I _D	3	А
Drain Current-Pulsed (Note 1)	I _{DM}	10	А
Single pulse avalanche Current (Note 5)	las	8	А
Single pulse avalanche energy (Note 5)	E _{AS}	16	mJ
Maximum Power Dissipation	P _D	1.7	W
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	$^{\circ}$

Thermal Characteristic

Thermal Resistance,Junction-to-Ambient (Note 2)	R _{θJA}	73.5	°C/W
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Electrical Characteristics (T_A=25[°]Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	Igss	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} ,I _D =250µA	0.9	1.3	2.0	V
Dunin Course On Chata Basistana	_	V _{GS} =10V, I _D =3A	-	68	78	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =3A	1	80	96	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =3A	-	3	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	// -20/4/ -0//	-	270	-	PF
Output Capacitance	Coss	$V_{DS}=30V,V_{GS}=0V,$ F=1.0MHz	-	16	-	PF
Reverse Transfer Capacitance	C _{rss}	H=1.0WHZ	-	15	-	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}	5	-	5	-	nS
Turn-on Rise Time	t _r	V _{DD} =30V,I _D =3A	-	10	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{GEN} =1 Ω	-	12	-	nS
Turn-Off Fall Time	X t _f		-	8	-	nS
Total Gate Charge	Qg	\/ 00\/ L 0A	-	10.2	-	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=30V,I_{D}=3A,$	-	1.8	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	2.2	-	nC
Drain-Source Diode Characteristics	·			•		
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =3A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	3	Α

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25°C, V_{DD} =30V, V_{G} =10V,L=0.5mH,Rg=25 Ω



Typical Electrical and Thermal Characteristics

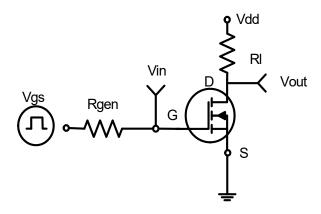


Figure 1:Switching Test Circuit

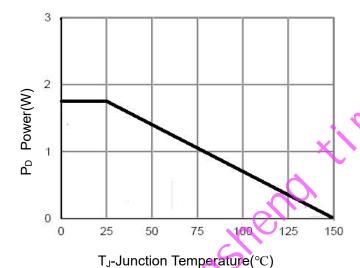


Figure 3 Power Dissipation

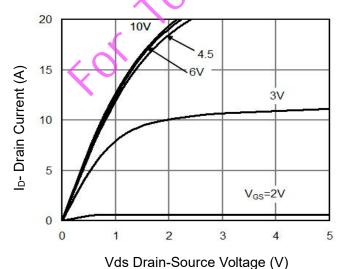


Figure 5 Output Characteristics

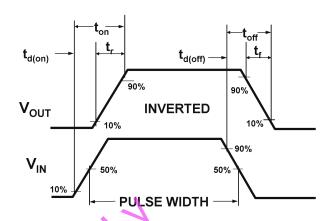
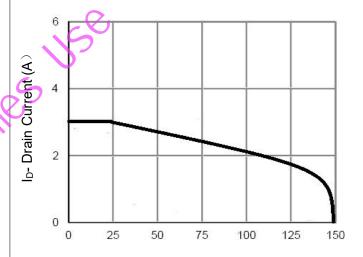


Figure 2:Switching Waveforms



T_J-Junction Temperature(°C)

Figure 4 Drain Current

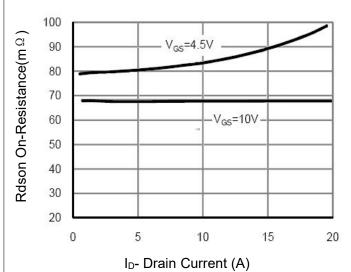


Figure 6 Drain-Source On-Resistance



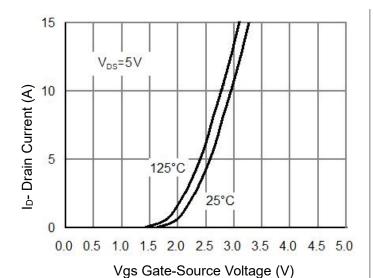
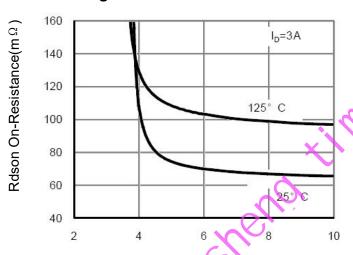
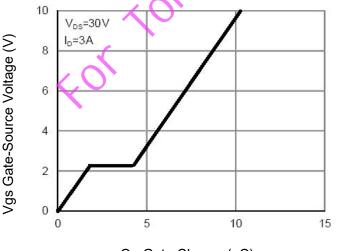


Figure 7 Transfer Characteristics



Vgs Gate-Source Voltage (V)

Figure 9 Rdson vs Vgs



Qg Gate Charge (nC) Figure 11 Gate Charge

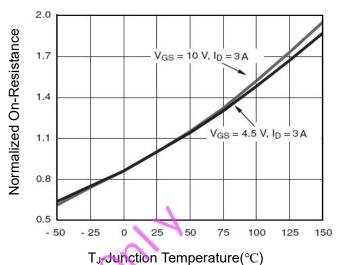


Figure 8 Drain-Source On-Resistance

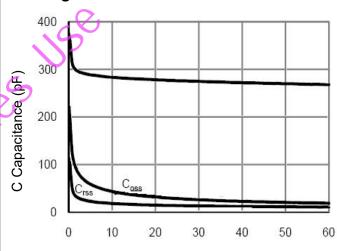


Figure 10 Capacitance vs Vds

Vds Drain-Source Voltage (V)

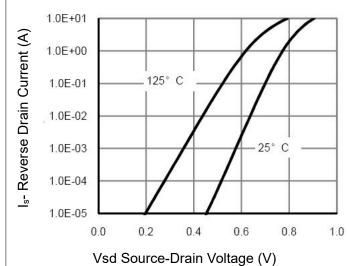


Figure 12 Source- Drain Diode Forward



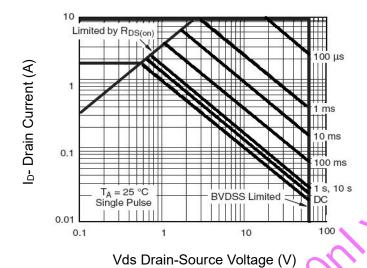


Figure 13 Safe Operation Area

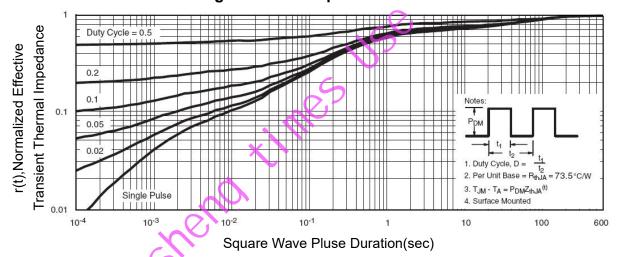
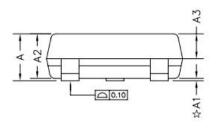
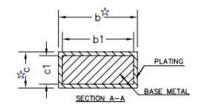


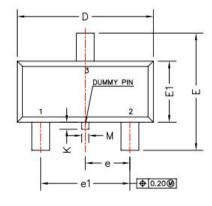
Figure 14 Normalized Maximum Transient Thermal Impedance

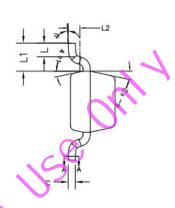


SOT-23(E) Package Information









	Cumbal	Millimeters		
	Symbol	Min.	Max.	
	A	0.89	1.12	
4	A1	0.01	0.10	
	A2	0.88	1.02	
No	A3	0.43	0.63	
5	b	0.36	0.50	
	b1	0.35	0.45	
	С	0.14	0.20	
	c1	0.14	0.16	
	D	2.80	3.00	
	E	2.35	2.64	
	E1	1.20	1.40	
	е	0.90	1.00	
	e1	1.80	2.00	
	L	0.40	0.60	
	L1	0.6	REF	
	L2	0.25	BSC	
	M	0.10	0.25	
	K	0.00	0.25	
	θ	0°	8°	
	θ1	10°	14°	
	θ2	10°	14°	



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